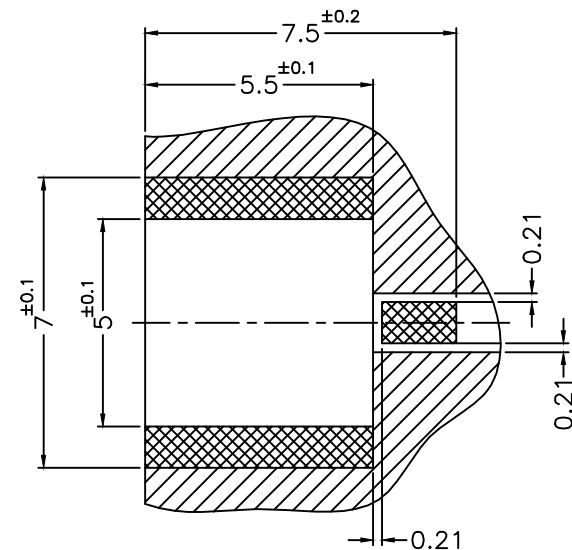
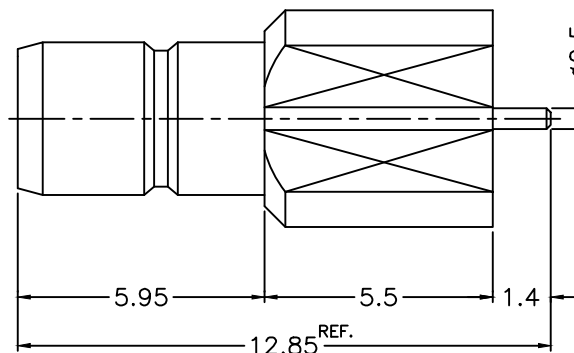
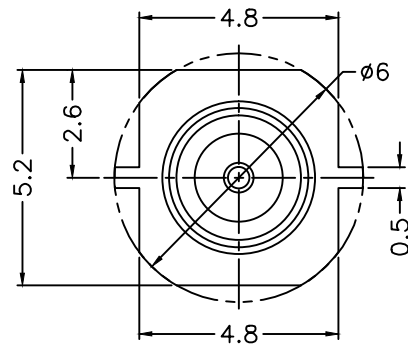


REVISIONS		
ISS	ZONE	DESCRIPTION\PER REQUEST\DATE
A2	A-5	PART NO. WAS DELETED\N/A\08-22-'12



RECOMMENDED
MOUNTING HOLE
(建議架設孔)

NOTES: FINISH (PLATING THICKNESS IN MICRO-INCHES)

1. BRASS
2. GOLD PL. 3 MIN. THICK OVER NICKEL PL. 50 MIN. THICK
OVER COPPER PL. 50 MIN. THICK
3. GOLD PL. 30 MIN. THICK OVER NICKEL PL. 50 MIN. THICK
OVER COPPER PL. 50 MIN. THICK
4. TEFLON

						DIMENSIONS ARE IN MILLIMETERS				PART NO.		G.L.I.			
						UNLESS OTHERWISE SPECIFIED TOLERANCES									
						0.5-6 = ±0.2				APPROVED		DATE 08-22-'12		TITLE SMB SMT JACK FOR EDGE-CARD	
						6-30 = ±0.4									
						30-120 = ±0.6				CHECKED		DATE 08-22-'12		DRAWING NO. 500-1251S3-50	
						120-315 = ±1									
						315-1000 = ±1.6				DRAWN		DATE 08-22-'12		FILE NO. R:\D\G\DWG\500\1251S3\50	
						1000-2000 = ±2.4									
3	CONTACT PIN	NOTE 1	NOTE 3	1	500-1251S1-3	SCALE	6/1	ISSUE	A2						
2	INSULATOR	NOTE 4	NATURAL	1	500-1251S3-2 -50T										
1	BODY	NOTE 1	NOTE 2	1	500-1251S3-1										
NO.	DESCRIPTION	MATERIAL	FINISH	Q'TY	DRAWING NO.										

G.L.I.

SMB SMT JACK FOR EDGE-CARD

500-1251S3-50

FILE NO. R:\D\G\DWG\500\1251S3\50

A